



N-Channel 150-V (D-S) 175 °C MOSFET

PRODUCT SUMMARY			
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A)	
150	0.052 at V _{GS} = 10 V	25	
150	0.060 at V _{GS} = 6 V	23	

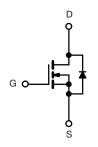
• TrenchFET

- TrenchFET® Power MOSFET
- 175 °C Junction Temperature
- PWM Optimized
- 100 % R_g Tested
- Compliant to RoHS Directive 2002/95/EC



APPLICATIONS

· Primary Side Switch



N-Channel MOSFET

TO-252	
	Drain Connected to Tab
G D S	
Top View	

Ordering Information:

SUD25N15-52-E3 (Lead (Pb)- free)

ABSOLUTE MAXIMUM RATINGS T _A = 25 °C, unless otherwise noted				
Parameter		Symbol	Limit	Unit
Drain-Source Voltage		V_{DS}	150	V
Gate-Source Voltage		V _{GS}	± 20	V
Continuous Drain Current /T 175 °C\b	T _C = 25 °C	I-	25	
Continuous Drain Current (T _J = 175 °C) ^b	T _C = 125 °C	I _D	14.5	
Pulsed Drain Current		I _{DM}	50	Α
Continuous Source Current (Diode Conduction)		I _S	25	
Avalanche Current		I _{AR}	25	
Repetitive Avalanche Energy (Duty Cycle ≤ 1 %)	L = 0.1 mH	E _{AR}	31	mJ
Maximum Paucer Discinction	T _C = 25 °C	P _D	136 ^b	W
Maximum Power Dissipation	T _A = 25 °C] ' D	3 ^a	, vv
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Junction-to-Ambient ^a	t ≤ 10 s	- R _{thJA}	15	18	°C/W
Junction-to-Ambient*	Steady State		40	50	
Junction-to-Case (Drain)		R _{thJC}	0.85	1.1	

Notes:

- a. Surface Mounted on 1" x 1" FR4 board.
- b. See SOA curve for voltage derating.

SUD25N15-52

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Parameter	Symbol	Test Conditions	Min.	Typ. ^a	Max.	Unit
Static					l l	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	150			V
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2		4	V
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA
		V _{DS} = 150 V, V _{GS} = 0 V			1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 150 V, V _{GS} = 0 V, T _J = 125 °C			50	μΑ
		V _{DS} = 150 V, V _{GS} = 0 V, T _J = 175 °C			250	
On-State Drain Current ^b	I _{D(on)}	V _{DS} = 5 V, V _{GS} = 10 V	50			Α
		V _{GS} = 10 V, I _D = 5 A		0.042	0.052	
h		V _{GS} = 10 V, I _D = 5 A, T _J = 125 °C			0.109	Ω
Drain-Source On-State Resistance ^b	R _{DS(on)}	V _{GS} = 10 V, I _D = 5 A, T _J = 175 °C			0.145	
		V _{GS} = 6 V, I _D = 5 A		0.047	0.060	
Forward Transconductance ^b	9 _{fs}	V _{DS} = 15 V, I _D = 25 A		40		S
Dynamic ^a						
Input Capacitance	C _{iss}			1725		
Output Capacitance	C _{oss}	$V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		216		pF
Reverse Transfer Capacitance	C _{rss}			100		
Total Gate Charge ^c	Qg			33	40	
Gate-Source Charge ^c	Q_{gs}	$V_{DS} = 75 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 25 \text{ A}$		9		nC
Gate-Drain Charge ^c	Q_{gd}			12		
Gate Resistance	R_{g}		1		3	Ω
Turn-On Delay Time ^c	t _{d(on)}			15	25	
Rise Time ^c	t _r	V_{DD} = 50 V, R_L = 3 Ω		70	100	
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong 25 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 2.5 \Omega$		25	40	ns
Fall Time ^c	t _f			60	90	
Source-Drain Diode Ratings and Cha	racteristics 7	Γ _C = 25 °C		•		
Pulsed Current	I _{SM}				50	Α
Diode Forward Voltage ^b	V_{SD}	I _F = 25 A, V _{GS} = 0 V		0.9	1.5	V
Source-Drain Reverse Recovery Time	t _{rr}	I _F = 25 A, dl/dt = 100 A/μs		95	140	ns

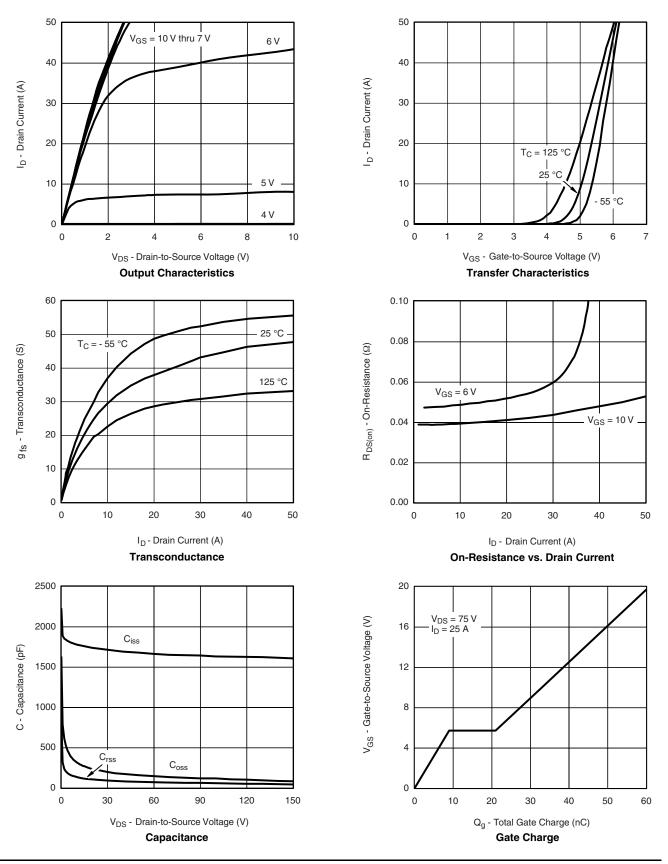
Notes:

- a. Guaranteed by design, not subject to production testing.
- b. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



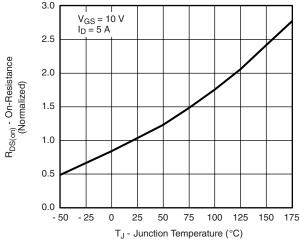
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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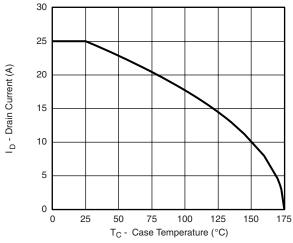
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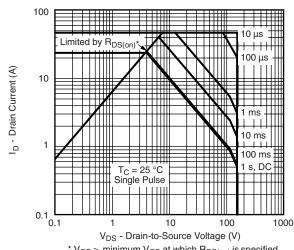
On-Resistance vs. Junction Temperature

Source-Drain Diode Forward Voltage

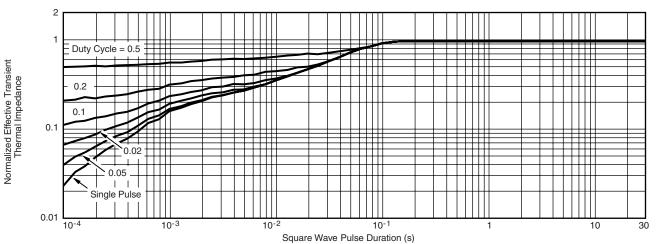
THERMAL RATINGS



Maximum Avalanche Drain Current vs. Case Temperature



* V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified **Safe Operating Area**



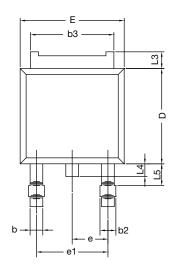
Normalized Thermal Transient Impedance, Junction-to-Case

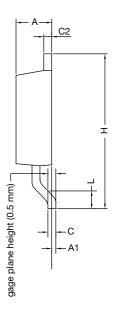
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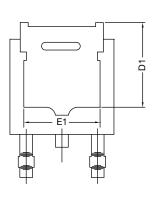


TO-252AA Case Outline

VERSION 1: FACILITY CODE = Y







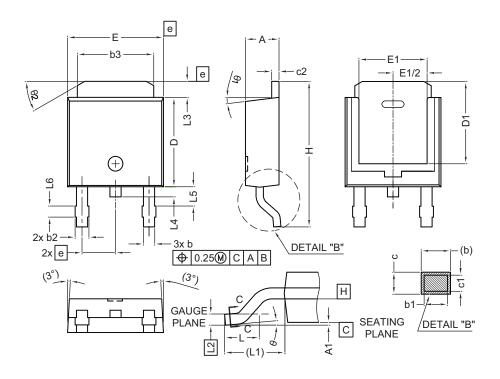
	MILLIMETERS		
DIM.	MIN.	MAX.	
А	2.18	2.38	
A1	-	0.127	
b	0.64	0.88	
b2	0.76	1.14	
b3	4.95	5.46	
С	0.46	0.61	
C2	0.46	0.89	
D	5.97	6.22	
D1	4.10	-	
Е	6.35	6.73	
E1	4.32	=	
Н	9.40	10.41	
е	2.28 BSC		
e1	4.56 BSC		
L	1.40	1.78	
L3	0.89	1.27	
L4	-	1.02	
L5	1.01	1.52	

Note

• Dimension L3 is for reference only



VERSION 2: FACILITY CODE = N



	MILLIMETERS		
DIM.	MIN.	MAX.	
Α	2.18	2.39	
A1	-	0.13	
b	0.65	0.89	
b1	0.64	0.79	
b2	0.76	1.13	
b3	4.95	5.46	
С	0.46	0.61	
c1	0.41	0.56	
c2	0.46	0.60	
D	5.97	6.22	
D1	5.21	-	
Е	6.35	6.73	
E1	4.32	-	
е	2.29 BSC		
Н	9.94	10.34	

	MILLIMETERS		
DIM.	MIN.	MAX.	
L	1.50	1.78	
L1	2.74	ref.	
L2	0.51	BSC	
L3	0.89	1.27	
L4	-	1.02	
L5	1.14	1.49	
L6	0.65	0.85	
θ	0°	10°	
θ1	0°	15°	
θ2	25°	35°	

Notes

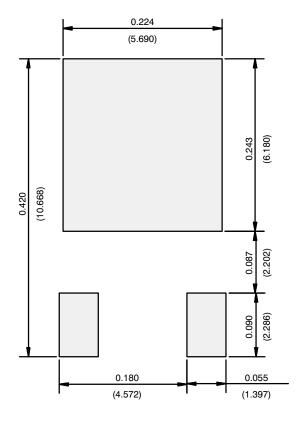
- Dimensioning and tolerance confirm to ASME Y14.5M-1994
- All dimensions are in millimeters. Angles are in degrees
- Heat sink side flash is max. 0.8 mm
- · Radius on terminal is optional

ECN: E19-0649-Rev. Q, 16-Dec-2019

DWG: 5347



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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